

# AN12291

## IP Binding on NXP LPC MCUs featuring on-chip Flash

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Application note

### Document information

Info	Content
<b>Keywords</b>	PUF, security, IP binding, secure boot, key storage
<b>Abstract</b>	This application note describes how to develop applications on NXP LPC MCUs to provide strong protection for stored information and protect against reverse engineering and cloning. The protection of this software Intellectual Property (IP) is built on the use of an SRAM Physically Unclonable Function (PUF). The SRAM PUF uses entropy in uninitialized SRAM to create device unique keys that bind cryptographically protected software IP to a specific device.



**Revision history**

Rev	Date	Description
1.0	11062018	Initial version

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## 1. Introduction

This application note describes techniques to protect embedded applications on LPC 32-bit ARM microcontrollers (MCUs) from reverse engineering, unauthorized firmware tampering, overproduction and counterfeiting. The protection is provided by binding the firmware and configuration information to the unique physical properties of the SRAM of MCU. The software Intellectual Property (IP) is bound to a specific device by an encryption process that uses cryptographic keys derived from a Physically Unclonable Function (PUF). Since these keys are unclonable and device-unique, the encrypted information that is stored is readable only by the authorized device. This *device-unique* encryption makes it difficult for an attacker to reverse engineer or modify the firmware. The overall process supports:

- A device-unique unclonable identity that can be cryptographically authenticated.
- Code authentication to ensure firmware may only be installed and updated by the OEM.
- Device-unique encryption keys to protect stored information from cloning, reverse engineering or modification.
- Optional version number validation to ensure that only new firmware updates are installed to prevent *roll-back attacks*.
- Additional confidential information can be protected to support application services. This information may be additional keys, trust roots or configuration information. This sensitive data has the same strong device-unique protection as the firmware and is strongly protected from extraction.
- Additional secret keys may also be generated by the PUF APIs to support strong device authentication using symmetric keys, public keys and/or public key certificates.

The process to design and field a secure embedded application using PUF is described. The solution is software-based but has implications on the system design and the manufacturing test process. Software modules are provided for integration with production test fixtures and applications. An IP binding *Tool Suite* is available to protect firmware and is used to create both factory installed images and images for over-the-air upgrades.

### 1.1 Physically unclonable functions

Like a snowflake, the atomic structure of every semiconductor device is different. These differences in atomic structure are expressed in the power-up state of uninitialized SRAM which forms a unique pattern for every device, like a *silicon fingerprint*. Keys derived from the SRAM PUF are not stored *on the chip* but are extracted *from the chip*, only when needed. They are only present in the chip during a short time window. When the SRAM is not powered, there is no key present on the chip. It makes the solution secure from reverse engineering and key extraction.

## 1.2 IP binding overview

The *binding* of software IP to a device uses a Unique-Device Secret (UDS) to encrypt stored information. The UDS key is derived from the SRAM PUF and provides the foundation of the security assurances. The UDS may also be used to derive a unique identifier for device identification and authentication. A wide range of keys, both symmetric and asymmetric, can be derived from this initial Root of Trust (RoT) for use by embedded applications. This application note focuses on the use of the UDS in an IP binding solution that protects OEM firmware and configuration information. Developers may also use the PUF based security for other security requirements within their applications.

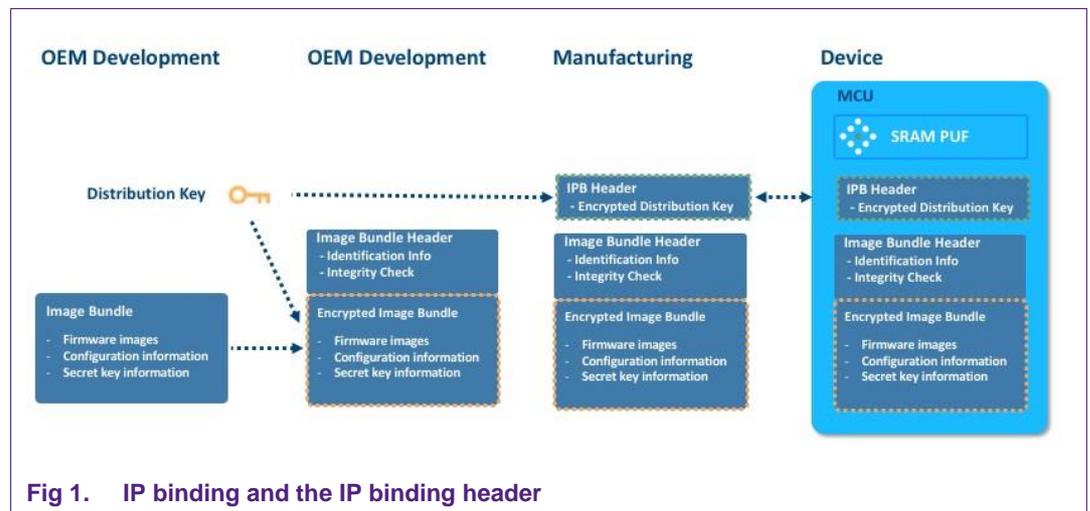


Fig 1. IP binding and the IP binding header

The encryption process that binds an image bundle to a device is illustrated in Fig 1. The OEM creates a firmware image and may bundle the image with additional secrets and configuration information. The image is protected by the OEM using a symmetric distribution key. The encryption process adds a header to the image bundle that identifies the protected bundle and provides integrity checks that are validated when decrypted. At the manufacturing facility, each device is uniquely authorized to decrypt the bundle by the creation of an IP binding header. This header contains the distribution key encrypted in a key that is uniquely generated from the SRAM PUF of the device. For protection of threats in manufacturing the distribution key should be securely stored and managed in a Hardware Security Module (HSM). Since the header is created with a PUF-derived secret, its encapsulated key is protected from extraction or use by any device other than the bound device.

The distribution key in the header will be set to the same key for all devices of the same model. It allows the same encrypted image bundle to be installed into a series of devices. The installation and distribution of the IP in the images is protected and the same distribution key may subsequently be used to create upgrade images.

The headers in the image bundle include a version number. The upgrade process may check this version number and include enforcement of monotonically increasing version numbers to prevent roll-back attacks.

The IP binding header may also be configured to include a unique distribution key per device. It provides the ability to control the distribution of images to individual devices.

## 2. Implementing IP binding

This section provides additional details and example code snippets to help developers create and deploy IP binding solutions.

### 2.1 Design

PUF device-unique keys provide a strong Root-of-Trust (RoT) for a system design. To use PUF, an embedded application must accommodate the use of uninitialized SRAM during the boot process to initialize and extract secret keys. An example of the SRAM memory allocation with PUF is shown in [Fig 2](#).

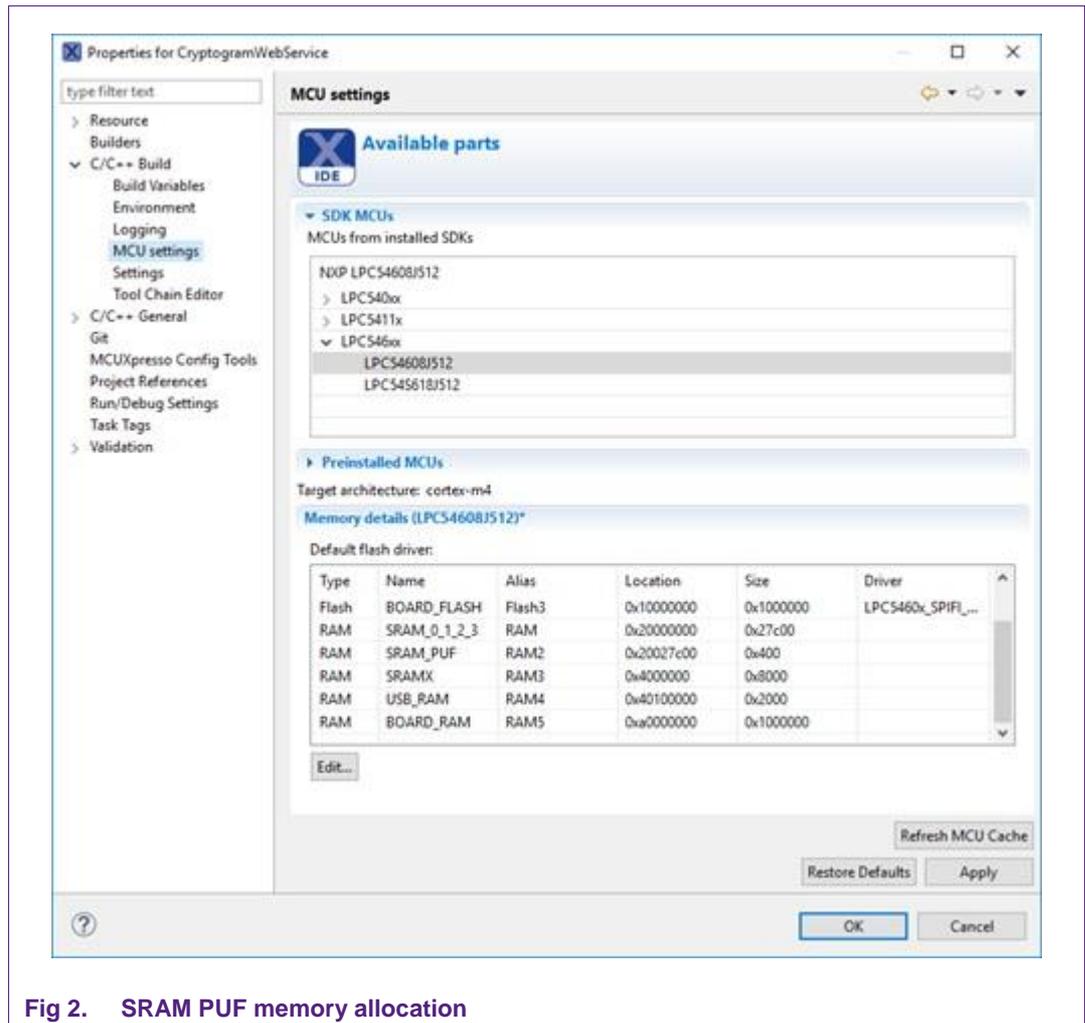


Fig 2. SRAM PUF memory allocation

The design must also ensure that the memory usage and OTP settings for the MCU are appropriate for the security design. Devices are only as secure as their overall configuration and designers should ensure that the locking mechanisms provided by NXP LPC MCUs are used correctly to protect the system. SWD and debug features must be disabled by the appropriate OTP settings.

## 2.2 Creation of a protected image bundle

Images are created and tested using the normal build process. Before protection of the image, it may be bundled with another configuration and secret key information. It allows application-unique roots of trust and authentication keys to be securely transmitted and installed with the firmware image.

The image bundle is encrypted with a distribution key using the IP Binding (IPB) tool. The IP binding tool suite is a command-line tool used to protect firmware images and provision additional keys. It is used in the software tool chain in the build/release of OEM process. Additionally, it can be used at an over-the-air update server for individual on-the-fly protection of the updated code images.

The tool suite uses an IPB\_HEADER from an individual chip to extract its configured protection profile (authentication, encryption, anti-rollback) in order to select the protection options to be applied. It then takes an unprotected code image and optional additional keys and protects the code and keys using the distribution key to result in a protected code image. The latter is processed by the IPB firmware. When anti-rollback is active, the tool reads a 32-bit image version number from a file and increments the version number inside that file.

## 2.3 OEM device provisioning

A product is personalized in the OEM facility using a manufacturing tool that is used to test and program the device; see [Fig 3](#). The cryptographic processing using the master distribution key should be within a Hardware Security Module (HSM) when the manufacturing facility is not fully trusted to protect this key.

The manufacturing tool starts the personalization process by injecting and running an *enrollment image* into a device. This code is transient and only runs once.

The functions of the enrollment image include:

- Device test functions.
- PUF initialization and device-unique key creation.
- Extraction of device unique public keys.
- Creation and storage of the IP binding header device in external flash.
- Loading the protected image bundle into flash.
- Obtaining a wrapped firmware distribution key and writing the device unique IPB header to NV memory.
- Locking down the device to prevent use of SWD and boundary scans and preventing any subsequent provisioning of the device.

The enrollment image is specific to an MCU and may include application specific testing and initialization. The PUF initialization and IP binding header functionalities must be integrated with the existing enrollment image software. Sample code for the PUF initialization and IP binding functions are provided for this integration in [Section 6.1](#).

The PUF unique keys are used to create a unique identifier for the device. It may be extracted and stored for subsequent tracking of the product.

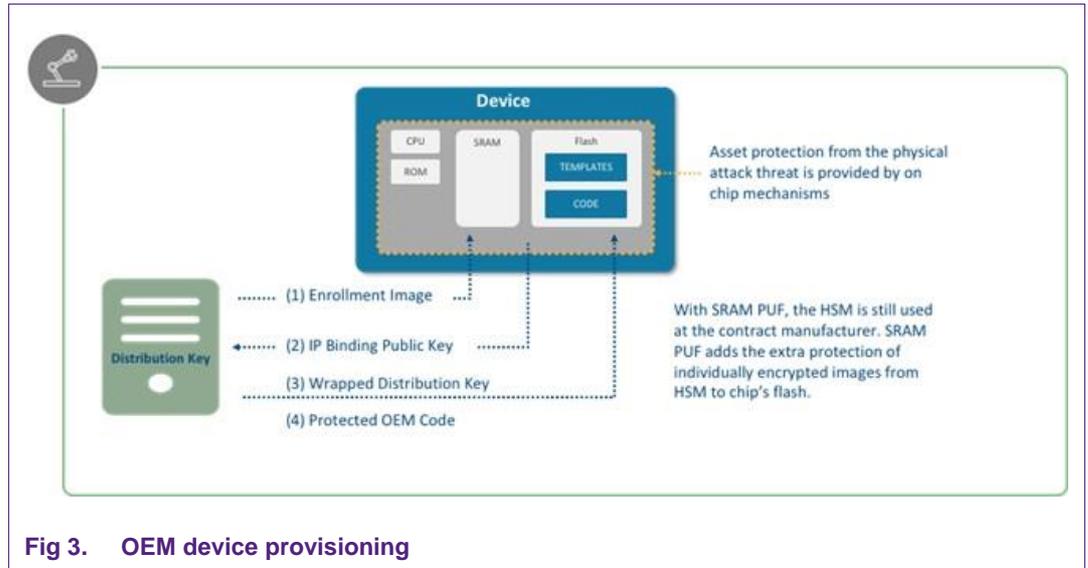


Fig 3. OEM device provisioning

## 2.4 Secure boot using SRAM PUF

On boot, the device creates the device unique secret keys using the SRAM PUF. This device firmware encryption key is then used to decrypt the IP binding header which provides the distribution key to decrypt and authenticate the image bundle and then run the unwrapped firmware. The integration of these capabilities is supported by an IP binding firmware module that provides all of the required PUF and encryption functionality, as described in [Section 4](#).

Example code illustrating how to integrate a secure boot process is provided in [Section 6.2](#).

## 3. Format specifications

The format of the IP binding header and image bundle header is described in this section. The IP binding header is encrypted with a PUF-derived key that is unique to a single device. The image bundle header is unique for an encrypted firmware image. The encrypted image bundle may be used with multiple devices and each device is enabled to use the bundle by giving it a unique IP binding header which contains a common distribution key encrypted for the specific device.

### 3.1 IP binding header

The IP binding header is a device unique sequence of octets that enables the decryption of a provided firmware image. The header contains three fields:

- Security options that describes if anti-rollback protection is required.
- Encrypted distribution key.
- A Message Authentication Code (MAC), used to provide a strong integrity check of the security.

The format of these fields is described below:

```
1  IPB_HEADER
2  {
3      uint32_t security_options; /* anti_rollback flags */
4      uint8_t encrypted_distribution_key[32];
5      uint8_t IPB_HDR_MAC[32]; /* MAC of prior two fields using PUF derived key*/
6  }
```

The options are set when the IP binding header is created. The options include the rollback policy and the ability to support null encrypt for use in debug and development. Example code and usage are provided in [Section 6](#).

### 3.2 Image bundle header format

The format of image bundle header is described below:

```
7  IMG_HEADER
8  {
9      security_version[4]
10     version_counter[4]
11     image_size[4]
12     additional_keys_size[4]
13     jump_offset[4]
14     hash_encrypted_additional_keys[32] /* SHA256 */
15     hash_encrypted_image[32] /* SHA256 */
16     IMG_HDR_MAC[32] /* MAC of everything up to here */
17 }
```

The additional keys stored in the protected image bundle are available to the developer to use for protecting trust roots and application-specific secrets.

## 4. IP binding firmware

The IP binding firmware is the device side of the solution, implemented in a single firmware module compiled to a binary library for the targeted platform. The IP binding firmware authenticates, decrypts to SRAM, and protects from rollback a binary code image and additional keys. Authentication, decryption, rollback protection are the features that can be individually activated or deactivated with the help of the IP binding tool; see [Section 5.1](#) and the resulting IPB\_HEADER data structure programmed into the device. The firmware image is internally interfaced to a device-unique key source.

## 5. IP binding tool description

### 5.1 IP binding tool suite

The IP binding tool suite v1.0 is a command-line tool used to protect firmware images and provision additional keys. It is used in the software tool chain in the build/release process of OEM. Additionally, it can be used at an over-the-air update server for individual on-the-fly protection of the updated code images.

The tool suite uses an IPB\_HEADER from an individual chip to extract its configured protection profile (authentication, encryption, anti-rollback) in order to select the protection options to be applied. It then takes an unprotected code image and optional additional keys and protects the code and keys using the distribution key to result in a protected code image. The latter is processed by the IP binding firmware. When anti-rollback is active, the tool reads a 32-bit image version number from a file and increments the version number inside that file.

## 6. Example code

The following examples provide code suitable for use in the development of a secure MCU product utilizing the SRAM PUF to bind software IP to the device's PUF device secret keys.

### 6.1 Code example for the enrollment image

The following code supports the initialization and use of PUF based keys during the initial device enrollment.

Enrollment involves the following:

- Programming a firmware image integrated with IPB firmware into the individual chip's NVM.
- Booting the chip and calling `bk_init()`, then `bk_enroll()` to produce the chip-unique and enrollment-unique Activation Code (AC).
- Calling `ipb_bind_header()` with the security profile configuration options in order to produce the chip-unique IPB\_HEADER.

**Note:** Enrolling again would produce a different AC, which cannot be used with a mismatching IPB\_HEADER – `ipb_bind_header()` would need to be repeated with the new AC

- The AC and the IPB\_HEADER is stored in on-chip NVM.
- Optionally, the AC and IPB\_HEADER is sent outside the chip for storage in a database for the purpose of backup recovery or server based activation without NVM.
- Use case-appropriate hardware access control mechanisms are permanently enabled. Examples of such are SWD/debug interface disablement, external flash write and erase disablement, changing an NVM variable to disable the command implementing the enrollment flow on the chip.

The code below should be integrated with the test and initialization software injected into a device by the manufacturing test system.

```

18  include/iidbroadkey.h
19  #define BK_SRAM_PUF_SIZE_BYTES          (1024)
20  #define BK_AC_SIZE_BYTES               (788)
21
22  /*
23   * REQUIREMENT:
24   *   Modify the Memory Map to allocate SRAM slice (RAM2)
25   *   (identify/allocate/isolate SRAM memory)
26   */
27   static __attribute__((section(".noinit.$SRAM2"))) uint8_t
sram_puf[BK_SRAM_PUF_SIZE_BYTES];
28   static uint8_t activation_code[BK_AC_SIZE_BYTES]__attribute__((aligned
(4)));
29
30
31  APP_PUF_store_activation_code( activation_code ) - Application dependent code to
write Activation Code (ex. Non-volatile memory)
32
33  APP_IPB_load_distribution_key( distribution_key ) - Application dependent
function to provide Application dependent Distribution Key
34
35  APP_IPB_store_counter( 0 ) - Initialize Monotonic Counter
36
37
38
39   /* Initialize SRAM dedicated for PUF */
40   ret_code = bk_init( sram_puf, BK_SRAM_PUF_SIZE_BYTES );
41   if (IID_SUCCESS != ret_code) break;
42
43   ret_code = bk_enroll( activation_code );
44   if (IID_SUCCESS != ret_code) break;
45
46   /* Application-Specific method for storage (i.e. flash, OTP)
47   ret_code = APP_PUF_store_activation_code( activation_code );
48   if (IID_SUCCESS != ret_code) break;
49
50   /* Application-Specific method for Distribution Key management
(cryptogram)
51   ret_code = APP_IPB_load_distribution_key( distribution_key );
52   if (IID_SUCCESS != ret_code) break;
53
54   ipb_header_t ipb_header;
55   ret_code = ipb_bind_header(
56   (IP_BIND_AUTHENTICATE | IP_BIND_ENCRYPT |
IP_BIND_NON_ROLLBACK),
57   distribution_key,
58   (ipb_header_t * const)&ipb_header );
59   if (IID_SUCCESS != ret_code) break;
60
61

```

```

62     /* Initialize Monotonic counter
63     * Application-Specific method for storage (i.e. NVRAM)
64     */
65     ret_code = APP_IPB_store_counter( 0 );

```

## 6.2 Code example for secure boot

The following code demonstrates how to use and integrate the IP binding firmware. This code is integrated into the boot process to support the PUF initialization process and the decryption and validation of the protected firmware.

```

66     static __attribute__((section(".noinit.$RAM2"))) uint8_t
        sram_puf[BK_SRAM_PUF_SIZE_BYTES];
67
68     #typedef struct PUF_boot_params {
69         const ipb_header_t * const ipb_header;
70         const uint8_t * const image_address;
71         uint8_t * const image_target_address;
72         uint8_t * const additional_keys_target_address;
73         uint32_t * const version_counter;
74         uintptr_t * const execution_address;
75     } PUF_boot_params_t;
76
77     PUF_boot_params_t params;
78     Bool bool_counter_updated;
79
80
81
82     APP_IPB_load_params( &params ) - Application dependent code to load boot params
83
84     APP_PUF_load_activation_code( activation_code ) - Application dependent code to
        read Activation Code (ex: Non-volatile memory)
85
86     APP_PUF_test_activation_code( activation_code ) - Application dependent code to
        validate activation code. For example, the activation code might be stored in
        flash and thus it might have initial clear values (i.e. zero or all-ones).
87
88
89     /* Load variables required by ipb_process_image()
90     * Application-Specific method for storage (nvram, header, etc.)
91     *
92     * Flash Storage:
93     * IPB_header - stored in OTP by Provisioning Image
94     * bound_image - stored in Flash; ipb_process_image output to SRAM
95     * counter - stored in NOR Flash
96     *
97     * Flashless Storage:
98     * IPB_header - stored in OTP by Provisioning Image
99     * bound_image - stored in SRAM at boot; ipb_process_image no output(XIP)
100    * counter - stored in NOR Flash

```

```

101     */
102     ret_code = APP_IPB_load_params( &params );
103     if (IID_SUCCESS != ret_code)    break;
104
105     /* Initialize SRAM dedicated for PUF */
106     ret_code = bk_init( sram_puf, BK_SRAM_PUF_SIZE_BYTES );
107     if (IID_SUCCESS != ret_code)    break;
108
109     /* Load Activation code
110     * Application-Specific method for storage
111     */
112     ret_code = APP_PUF_load_activation_code( activation_code );
113     if (IID_SUCCESS != ret_code)    break;
114
115     /* Test if Activation Code is Valid
116     * Application-Specific Method for Test (i.e. not all 0x0 or 0xFF)
117     * Start Only, Enroll is during Enrollment
118     */
119     ret_code = APP_PUF_test_activation_code( activation_code );
120     if (IID_SUCCESS != ret_code)    break;
121
122     /* System has valid Activation Code; Enroll would alter IPBindingHeader */
123     ret_code = bk_start( activation_code );
124     if (IID_SUCCESS != ret_code)    break;
125     ret_code = ipb_process_image(
126         params->ipb_header,
127         params->image_address,
128         params->image_target_address,
129         params->additional_keys_target_address,
130         params->version_counter,
131         &bool_counter_updated,
132         params->execution_address );
133     if (IID_SUCCESS != ret_code)    break;

```

### 6.3 Secure update details

The process for a secure update follows a similar procedure as the secure boot. Encrypted firmware images are created in an identical manner as the initial image used for the device. The firmware distribution process must also create and distribute a new IP binding header for each device authorized to use the firmware. Once the protected firmware bundle and binding header are delivered to a device, the bundle is decrypted in the same manner as the initial image. When the image security options require roll-back protection, the target device must maintain a version number in non-volatile memory. The stored version number is checked when roll-back protection is required and only loads the new image when it contains a larger version number. On acceptance of the new image, the device must update its stored reference counter.

```
134     /* Store Monotonic counter
135     *   Application-Specific method for storage (i.e. NVRAM)
136     */
137     if( counter_updated == true )
138         ret_code = APP_IPB_store_counter( params->version_counter );
```

#### 6.4 Additional protected information retrieval

The protected image bundle may include additional protected secrets. These secrets may be device unique configuration information or secret keys used for applications. This block of information is first in the image data and is of size *additional\_keys\_size* as provided by the header information.

## 7. Conclusion

This application note describes techniques to protect embedded applications using the PUF technology available on the NXP LPC54S0xx MCU family.

The physically unclonable keys derived from the PUF provide a strong root-of-trust for the identification of devices and the secure distribution of information to and from the device. IP binding uses device unique public keys as a foundation for the protection of firmware and configuration information. The PUF based root of trust may also be applied to other cryptographic services within a device. PUF derived keys may also be used to securely derive device unique keys for protocols like TLS, IPsec a SSH.

NXP has licensed the PUF technology from Intrinsic-ID. Addition information on the application of PUF technologies and IP binding may be obtained from Intrinsic-ID by accessing their website at <https://www.intrinsic-id.com/> or by emailing [info@intrinsic-id.com](mailto:info@intrinsic-id.com)

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